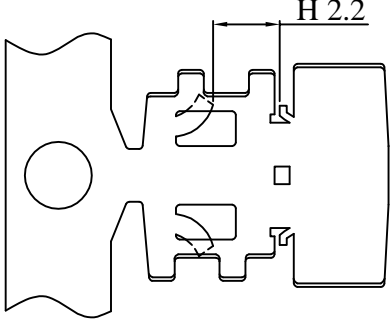
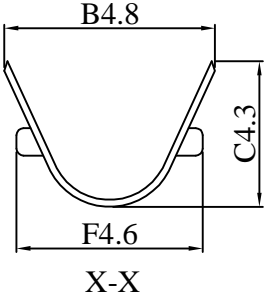
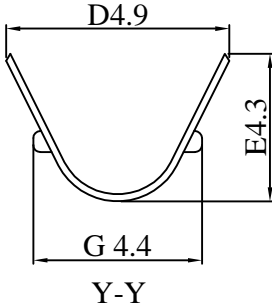
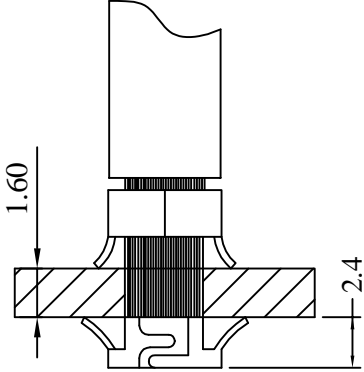
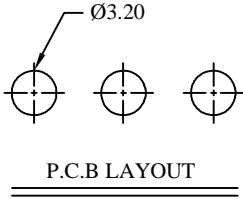
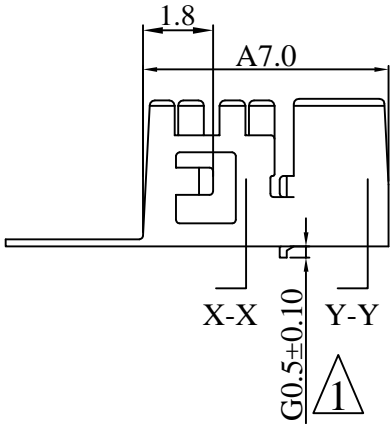
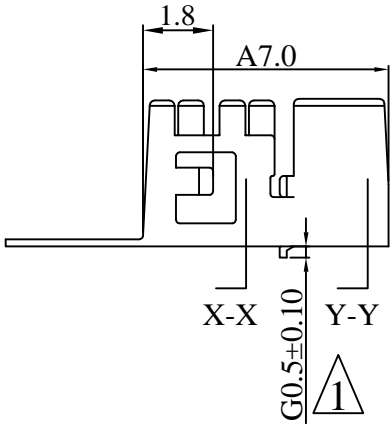
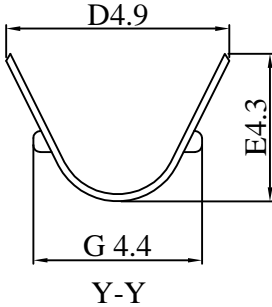
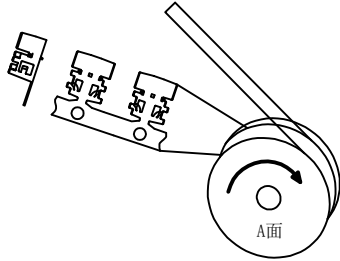



	1	2	3	4		
A				版本REV	日期	
				A2	2017-8-16	
B						
C					成品捲料方向. 如圖所示 端子料帶朝A面, 包腳向上	
D	NOTE:					
	1.THICKNESS: 0.20mm		5.P.C.BOARD HOLE: 3.2Ømm			
	2.MATERIAL: PHOSPHOR BRONZE		6.P.C.BOARD THICKNESS:1.60mm.			
	3.FINISH: TIN-PLAED 60µ"以上		7.STANDARD PACKING:4000PCS/R			
	4.APPLICABLE WIRE: AWG 18*4		8.此产品符合RoHS指令要求			
			9."-T"为先冲后镀, 镀亮锡.			
E	一般公差: GENERAL TOLERANCE		更改說明: REV.DESCRPTION		更改說明: REV.DESCRPTION	
	尺寸範圍DIM		① G0.45更改為0.5±0.10		④	
	.0	±0.20	②		⑤	
	.00	±0.15	③		⑥	
	.000	±0.10	核准APPD	朱小华	2017-8-16	
	文件編號		審核CHD	Tony	2017-8-16	模型:
	SC-EW-11		繪圖DWN	廖政庭	2017-8-16	料號: ITEM NO
比例: SCALE		 SHIH CHUAN ELECTRONICS			規格: SPEC	
					P.C.B 3.2Ø	